## (12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization International Bureau





(43) International Publication Date 17 February 2005 (17.02.2005)

**PCT** 

## (10) International Publication Number WO 2005/015969 A1

(51) International Patent Classification7: G02F 1/13

H05K 7/02,

(21) International Application Number:

PCT/EP2004/051064

(22) International Filing Date: 9 June 2004 (09.06.2004)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

03016060.0

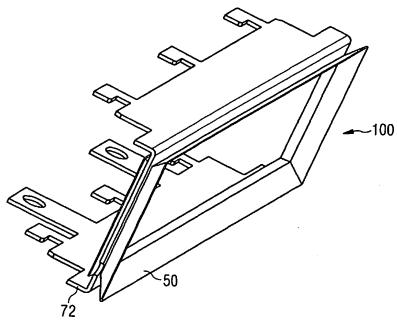
15 July 2003 (15.07.2003)

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- (81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.
- (84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

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(54) Title: COMPONENT CARRIER



(57) Abstract: The present invention relates to a component carrier which includes a frame (72) and a sealing lip (50). The frame includes walls defining an internal opening. The frame may be made of metal and the sealing lip of thermoplastic elastomer. The sealing lip is a single piece which is applied to the frame by injection molding or spraying. The frame may further include recesses or openings along the walls defining its cavity. The cooling thermoplastic elastomer may then grip or adhere to the walls so as to retain its shape. The current invention provides increased compensation tolerances for components accommodated therein.



## WO 2005/015969 A1



## Published:

with international search report

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